Kingbright

1.6X1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: APTB1612CGKQWDF

Green
White

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

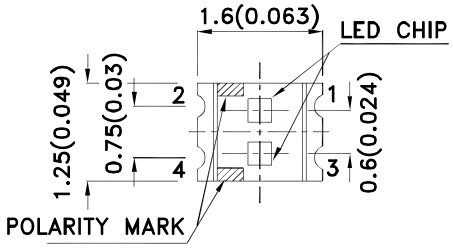
Features

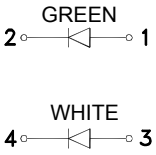
- 1.6mmx1.25mm SMT LED, 0.65mm thickness.
- Bi-color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

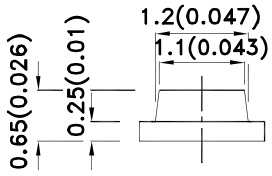
Description

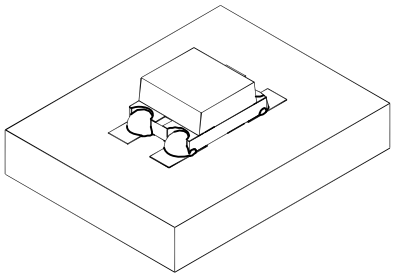
The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
The source color devices are made with InGaN Light Emitting Diode.
Static electricity and surge damage the LEDS.
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically grounded.

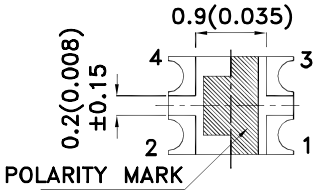
Package Dimensions











Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2(0.008") unless otherwise noted.
3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4.The device has a single mounting surface. The device must be mounted according to the specifications.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APTB1612CGKQWDF	Green (AlGaInP)	Yellow Fluorescent	20	55	120°
	White (InGaN)		120	220	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C [CGK]

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	I_F=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	I_F=20mA
C	Capacitance	Green	15		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Green	2.1	2.5	V	I_F=20mA
I_R	Reverse Current	Green		10	uA	V_R = 5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Electrical / Optical Characteristics at TA=25°C [QB-D (White)]

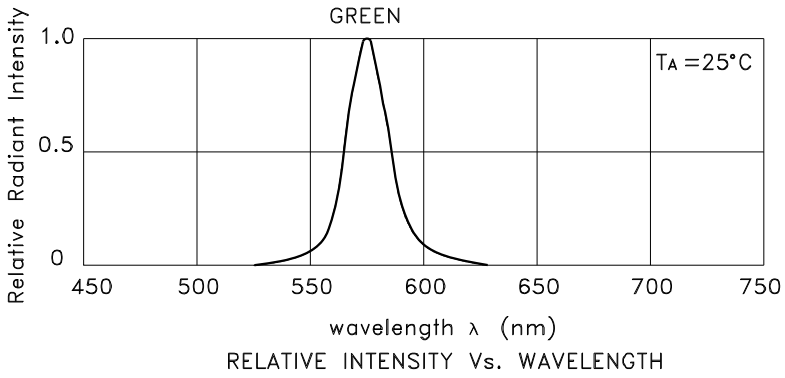
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
V_F [1]	Forward Voltage	White	3.3	4.0	V	I_F=20mA
I_R	Reverse Current	White		50	uA	V_R = 5V
x [2]	Chromaticity Coordinates	White	0.31			
y [2]			0.31			
C	Capacitance	White	100		pF	V_F=0V;f=1MHz

Notes:
1. Forward Voltage: +/-0.1V.
2: Measurement Tolerance Of The Chromaticity Coordinates Is ±0.01.

Absolute Maximum Ratings at TA=25°C

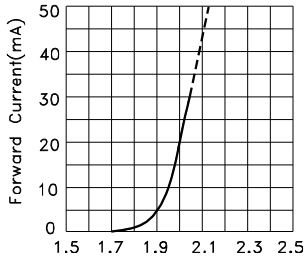
Parameter	Green	White	Units
Power dissipation	75	120	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	150	150	mA
Reverse Voltage	5		V
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

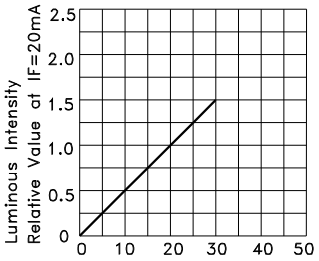


RELATIVE INTENSITY Vs. WAVELENGTH

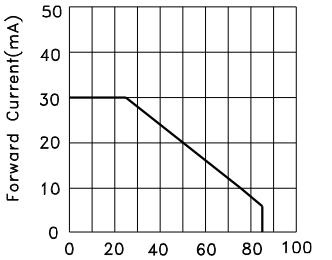
APTB1612CGKQWDF
Green



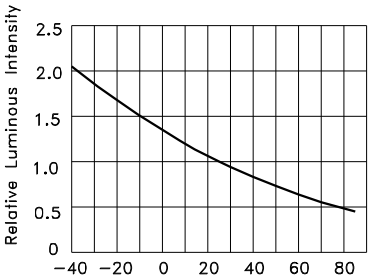
FORWARD CURRENT Vs.
FORWARD VOLTAGE



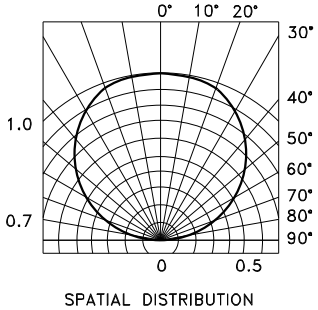
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

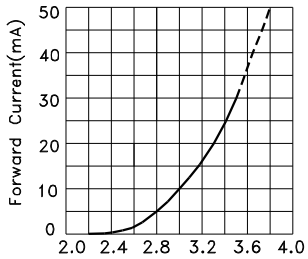


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

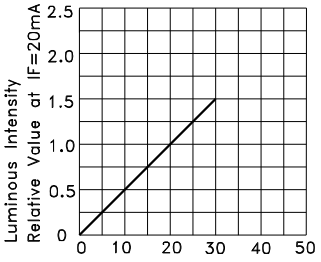


SPATIAL DISTRIBUTION

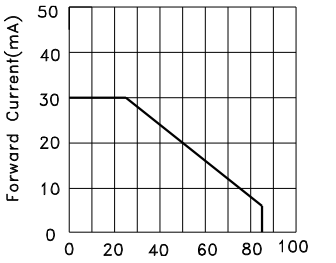
White



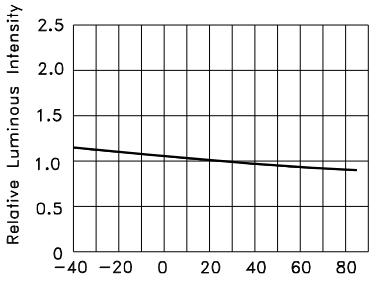
FORWARD CURRENT Vs.
FORWARD VOLTAGE



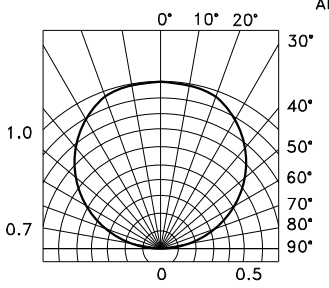
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



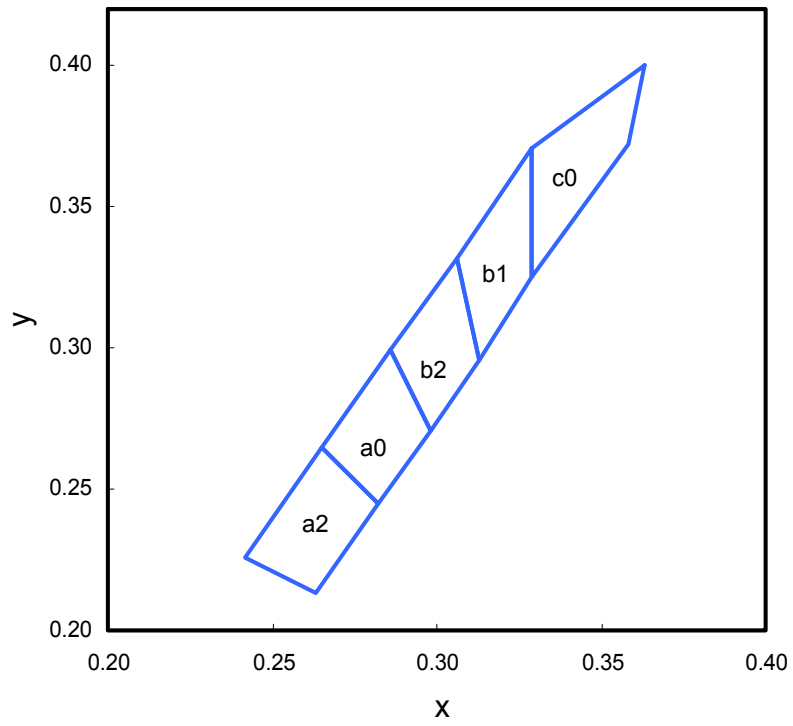
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

White **APTB1612CGKQWDF**

White CIE



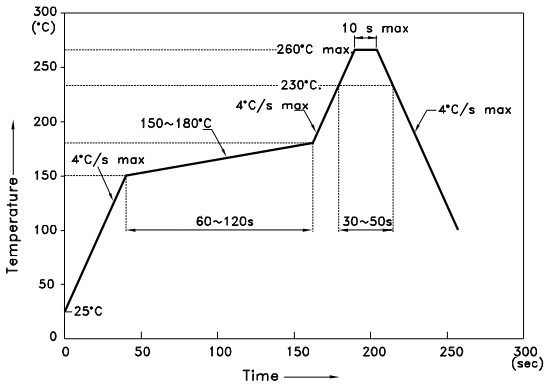
	x	y		x	y		x	y
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

Notes:
Shipment may contain more than one chromaticity regions.
Orders for single chromaticity region are generally not accepted.
Measurement tolerance of the chromaticity coordinates is ±0.01.

APTB1612CGKQWDF

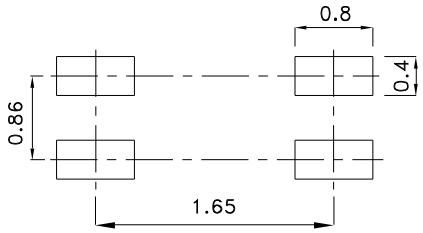
Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

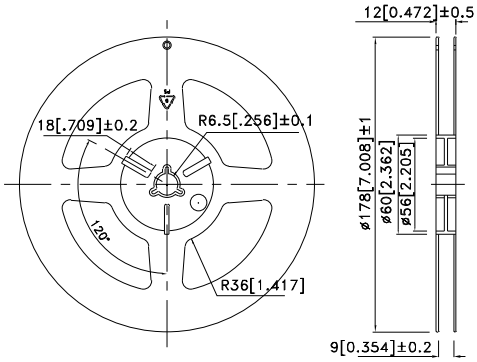


NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

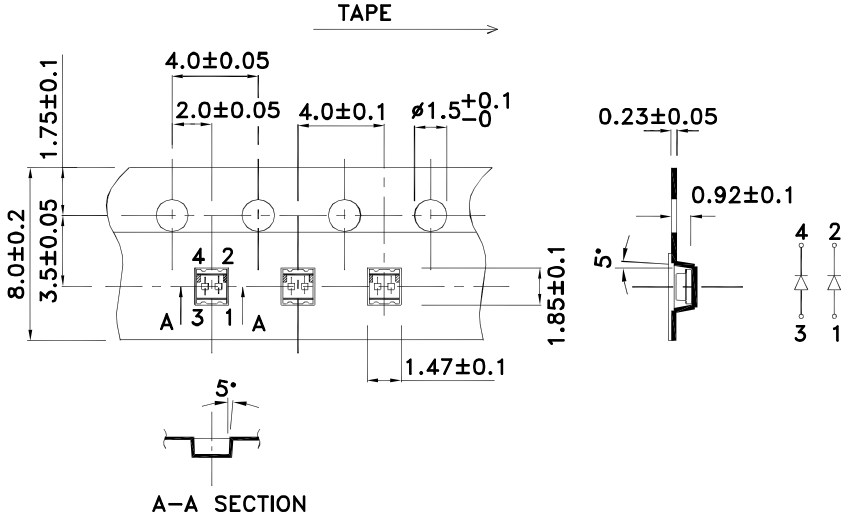
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS **APTB1612CGKQWDF**